

NOV 14 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Yew

Docket No.: TI-26239.1

Serial No.: 10/612,129

Examiner: Cao, Phat X.

Filed: 7/2/2003

Art Unit: 2814

For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC
SUBSTRATE

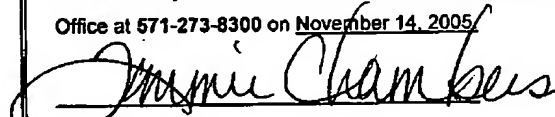
PRELIMINARY AMENDMENT

Honorable Assistant Commissioner
of Patents

Washington, D.C. 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being
transmitted by facsimile to the U.S. Patent and Trademark
Office at 571-273-8300 on November 14, 2005.


Temie Chambers

Prior to the examination of the above identified application, please amend the
above referenced Application as follows: